

Substitute Form PTO-1449 <i>Initials</i> MAR 01 2004 (37 CFR §1.98(b))	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 05770-189001	Application No. 10/658,597
Information Disclosure Statement by Applicant (Use several sheets if necessary)		Applicant Arnold P. Kehrli	
		Filing Date September 9, 2003	Group Art Unit 2838

U.S. Patent Documents

Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
DP	AA	5,469,044	11/21/95	Gyugyi et al.			
DP	AB	5,706,158	01/06/98	Mueller			
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						

Foreign Patent Documents or Published Foreign Patent Applications

Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation	
							Yes	No
	AI							
	AJ							
	AK							
	AL							
	AM							

Other Documents (include Author, Title, Date, and Place of Publication)

Examiner Initial	Desig. ID	Document
DP	AN	Ettedgui et al., "Potential Impact of High Temperature Superconducting Cables on Grid Reliability and Available Transfer Capacity: Power Flow Simulation Results", IEEE Transactions on Applied Superconductivity, Pages 145-150, 2002
DP	AO	Kelley et al., "Field Demonstration of a 24-kV Warm Dielectric HTS Cable", IEEE Transactions on Applied Superconductivity, Vol. II, No. 1, March 2001, Pages 2461-2466
DP	AP	Mihalic et al., "Power Transmission Control using Unified Power Flow Controller", http://leoants.te.uni-li.si/CD/data/flowcont.htm , October 2000
DP	AQ	Karl E. Stahlkopf, "Unconventional Ways to Increase Transmission Capacity", http://www.worldenergy.org/wec-g...s/2_24.asp?mode=print&x=44&y=1998
DP	AR	Stovall et al., "Installation and Operation of the Southwire 3-meter High-Temperature Superconducting Power Cable", IEEE Transactions on Applied Superconductivity, Vol. 11, No. 1, March 2001, Pages 2467-2472

Examiner Signature

Date Considered

1-23-06

EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.